

SUGGESTED PCB LAYOUT

| | REVISIONS | | | | | | |
|-----|--------------------|------------------|------|--|--|--|--|
| REV | DESCRIPTION | DATE | APPV | | | | |
| Α | PRODUCTION RELEASE | JHAGER 3/1/21 | | | | | |

NOTES: (UNLESS OTHERWISE SPECIFIED)

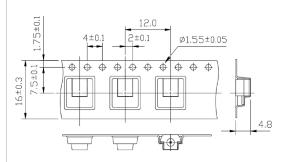
- 1. ALL DIMENSIONS ARE IN MILLIMETERS [IN].
- 2. DIMENSIONS APPLY AFTER FINISHING.
- MANUFACTURE TO BE COMPLIANT WITH EU ROHS DIRECTIVE, USE MATERIALS THAT DO NOT CONTAIN REACH SUBSTANCES OF VERY HIGH CONCERN >1000ppm, AND USE DRC CONFLICT-FREE SOURCED MATERIALS.

4.\INTERFACE MFG IAW MIL-STD-348B FULL INDENT.

- 5. UNLISTED GEOMETRY CONTROLLED BY SOLID MODEL AT CURRENT REVISION.
- 6. DURABILITY: 100 CYCLES MIN
- 7. OPERATING TEMPERATURE: -65°C +165°C
- 8. IMPEDANCE: 50Ω
- 9. FREQUENCY RANGE: 0-18GHz
- 10. CONTACT RESISTNACE: $6m\Omega$ [CENTER] $3m\Omega$ [OUTER]
- 11. DIELECTRIC: 320Vrms
- 12. PACKAGING TAPE AND REEL IAW EIA-481-B EMBOSSED CARRIER. PITCH:12, TAPE SIZE:16 AS SHOWN.
- 13. INSERTION LOSS: NTE .075 x √f (GHz)

| 3 | PIN, MAL, SMP, GOL/BeCu | | | |
|------|-----------------------------------|--|--|--|
| 2 | INSULATOR, PTFE, PIN SUPPORT, NAT | | | |
| 1 | BODY, SMP, CUTOUT, GOLD/BeCu | | | |
| ITEM | DESCRIPTION | | | |

TAPE AND REEL PACKAGING



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| DESIGNATED AGENTS. | | | | | |
|--------------------|--|-------------|--|--|--|
| MATERIAL: | INTERPRET DIMENSIONS AN TOLERANCES PER ASME Y14 | PROJECTION: | | | |
| BRASS BeCu | .X ±2.0 ANGLES: .XX ±1.00 .XXX ±.500 SURFAC | - | | | |
| FINISH: GOLD | DRAWN: JHAGER | DT: | | | |

ENGR:



159 ORT LANE MERLIN, OR 97532

TITLE:

CONNECTOR, SMP, PLUG, CUTOUTM BRD GOLD/BeCu

CUTOUTM BRD GOLD/BeCu

SIZE DWG. NO.

DT:

C-CONSMP024-G

DT: 10-JUL-08 SCALE: 5:1 DO NOT SCALE DRAWING SHEET 1 OF 1